



## Removing charges at IC pallet

### OUTLINE / PREVIOUS

**Delivery: Semiconductor equipment manufacturer**

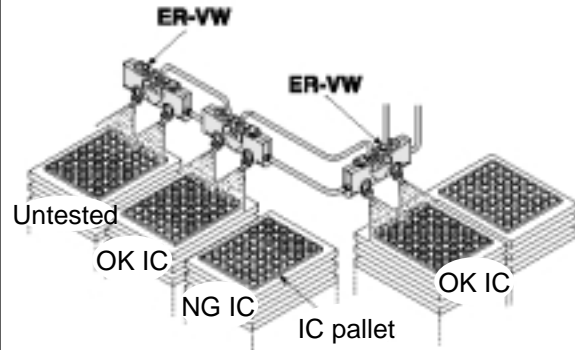
**Process: Package test process**

Static is to be removed from IC pallet before and after the test.

### PROBLEM

Compact static remover is required because there is no enough space in the device.

### SOLUTION



### MODEL / HOW TO

**ER-VW ER-VWAR80**

Joint kit **ER-VWAR80** is used to connect several units of **ER-VW**.

### BENEFIT 1 Compact and thin design

**ER-VW** is designed as W127 x H18.9 x D64.3mm, compact and thin. The nozzle angles can be adjusted so that **ER-VW** can be installed in places where there are space restrictions, such as internal space of equipment, or when installing in several adjacent lines.

### BENEFIT 2 Easy connections possible

**ER-VW** can be connected up to five units by using optional joint kit **ER-VWAR80**. Nozzle angle adjustment allows flexible layouts.

### BENEFIT 3 Nozzle angle adjustment mechanism

**ER-VW** has two nozzles which tips are screwed to adjust angles within a range of approx. 190 degrees. This allows easy and flexible angle adjustment even after installation.

